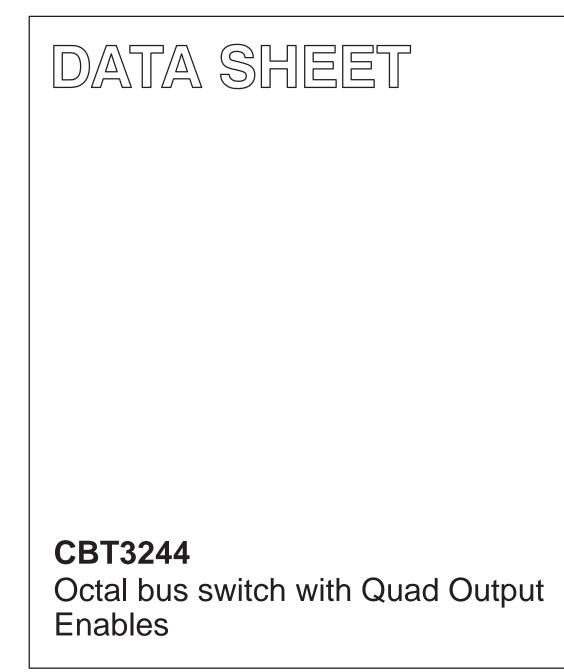
INTEGRATED CIRCUITS



Preliminary specification

1998 Dec 08



Philips Semiconductors



CBT3244

FEATURES

- Functionally equivalent to QS3244
- Standard '244-type pinout
- 5Ω switch connection between two ports
- TTL compatible control input levels
- Package options include plastic small outline (D), shrink small outline (DB), thin shrink small outline (TSSOP)

DESCRIPTION

The CBT3244 provides eight bits of high-speed TTL-compatible bus switching in a standard '244 device pinout. The low on-state resistance of the switch allows connections to be made with minimal propagation delay.

The CBT3244 device is organized as two 4-bit low-impedance switches with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the switch is on and data can flow from port A to port B, or vice versa. When \overline{OE} is high, the switch is open and high-impedance state exists between the two ports.

The CBT3244 is characterized for operation from -40°C to 85°C.

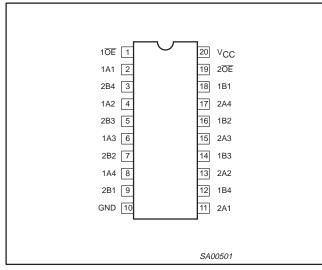
QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay An to Yn	C _L = 50pF; V _{CC} = 5V		ns
C _{IO(OFF)}	Pin capacitance (OFF state)	$V_{O} = 3V \text{ or } 0V$	6	pF
I _{CCZ}	Total supply current	Outputs disabled; V_{CC} =5.5V		μΑ

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
20-Pin plastic SO	–40°C to 85°C	CBT3244 D	CBT3244 D	SOT163-1
20-Pin Plastic SSOP Type II	-40°C to 85°C	CBT3244 DB	CBT3244 DB	SOT339-1
20-Pin Plastic TSSOP Type I	–40°C to 85°C	CBT3244 PW	CBT3244PW DH	SOT360-1

PIN CONFIGURATION

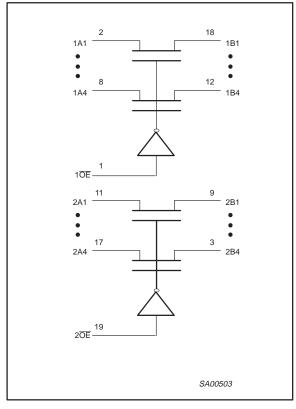


PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 19	1 <u>0E</u> , 2 <u>0E</u>	Output enable
2, 4, 6, 8	1A1–1A4	
11, 13, 15, 17	2A1–2A4	
18, 16, 14, 12	1B1–1B4	
9, 7, 5, 3	2B1–2B4	
10	GND	Ground (0V)
20	V _{CC}	Positive supply voltage

CBT3244

LOGIC SYMBOL



FUNCTION TABLE

INPUTS		OUTPUTS		
10E	2 <mark>0E</mark>	1A, 1B	2A, 2B	
L	L	1A = 1B	2A = 2B	
L	Н	1A = 1B	Z	
н	L	Z	2A = 2B	
н	Н	Z	Z	

H = High voltage level

L = Low voltage level

Z = High impedance "off" state

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
I _{IK}	DC input diode current	V _I < 0	-18	mA
VI	DC input voltage ³		-1.2 to +7.0	V
I _{OK}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	output in Off or High state	-0.5 to +7	V
I _{OUT}	DC output current	output in Low state	128	mA
T _{stg}	Storage temperature range		-65 to 150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

 The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
 The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

CBT3244

RECOMMENDED OPERATING CONDITIONS

SYMBOL	BOL PARAMETER		LIMITS		
STMBOL	PARAMETER	Min	Max	UNIT	
V _{CC}	DC supply voltage	4.5	5.5	V	
V _{IH}	High-level input voltage	2.0		V	
V _{IL}	Low-level Input voltage		0.8	V	
T _{amb}	Operating free-air temperature range	-40	+85	°C	

DC ELECTRICAL CHARACTERISTICS

				LIMITS		
SYMBOL PARAMETER		TEST CONDITIONS	T _{amb} = −40°C to +85°C			UNIT
			Min	Typ ¹	Max	1
V _{IK}	Input clamp voltage	$V_{CC} = 4.5V; I_I = -18mA$			-1.2	V
l _l	Input leakage current	V _{CC} = 5.5V; V _I = GND or 5.5V			±5	μA
Icc	Quiescent supply current ²	V_{CC} = 5.5V; I_{O} = 0, V_{I} = V_{CC} or GND			50	μA
ΔI _{CC}	Additional supply current per input pin ²	V_{CC} = 5.5V, one input at 3.4V, other inputs at V_{CC} or GND			3.5	mA
Cl	Control pins	V_{I} = 3V or 0, \overline{OE} = V_{CC}		3		pF
C _{IO(OFF)}	Power-off leakage current	$V_0 = 3V \text{ or } 0$		6		pF
		$V_{CC} = 4.5V; V_1 = 0V; I_1 = 64mA$		5	7	
r _{on} ³	On-resistance	$V_{CC} = 4.5V; V_1 = 0V; I_I = 30mA$		5	7	Ω
		V _{CC} = 4.5V; V ₁ = 0V; I _I = 15mA		10	15	1

NOTES:

1. All typical values are at V_{CC} = 5V, TA = 25 C

2. This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND

3. Measured by the voltage drop between the A and the B terminals at the indicated current through the switch.

On-state resistance is determined by the lowest voltage of the two (A or B) terminals.

AC CHARACTERISTICS

 $GND = 0V; t_{R}; C_L = 50pF$

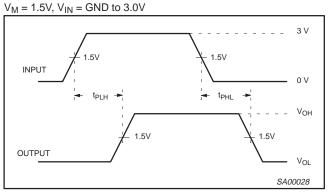
				74CB	UNIT	
SYMBOL	PARAMETER	PARAMETER FROM TO (INPUT) (OUTPUT)		T _{amb} = −40°C to +85 V _{CC} = +5.0V ±0.5V		
				Min	Max	
t _{pd}	Propagation delay ¹	A or B	B or A		.25	ns
t _{en}	Output enable time to High and Low level	OE	A or B	1.0	8.9	ns
t _{dis}	Output disable time from High and Low level	OE	A or B	1.0	7.4	ns

NOTES:

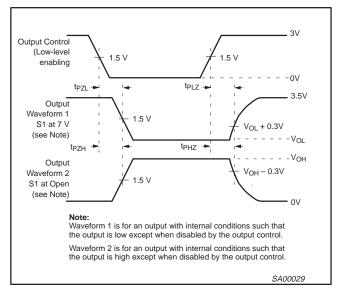
1. This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

CBT3244

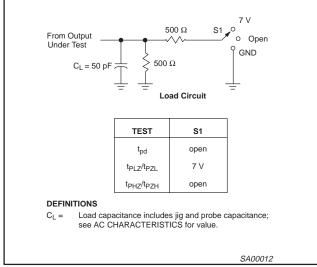
AC WAVEFORMS



Waveform 1. Input to Output Propagation Delays



Waveform 2. 3-State Output Enable and Disable Times

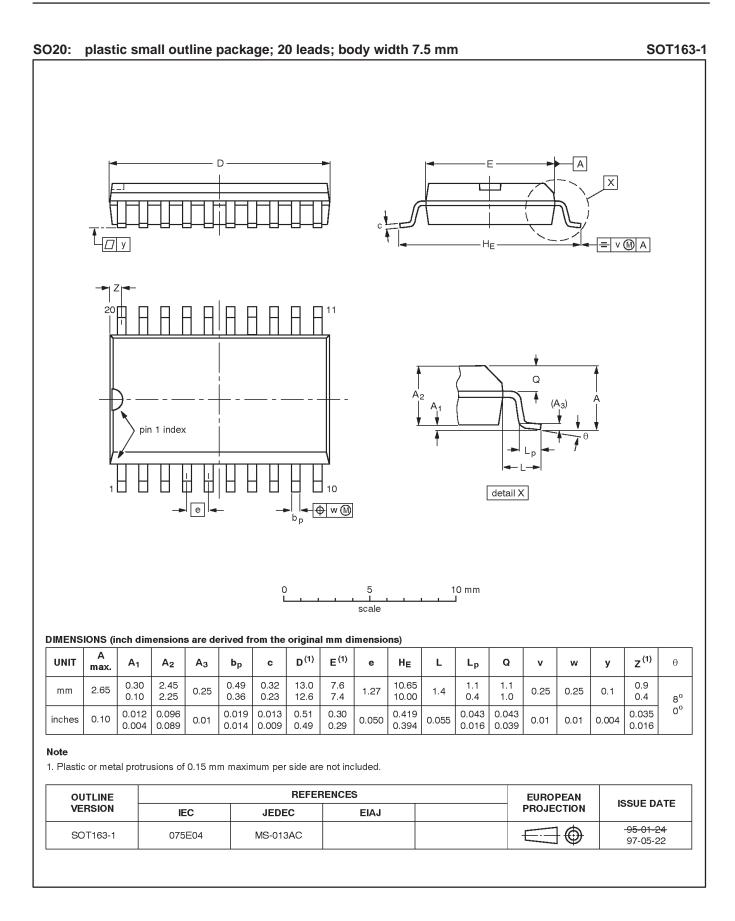


NOTES:

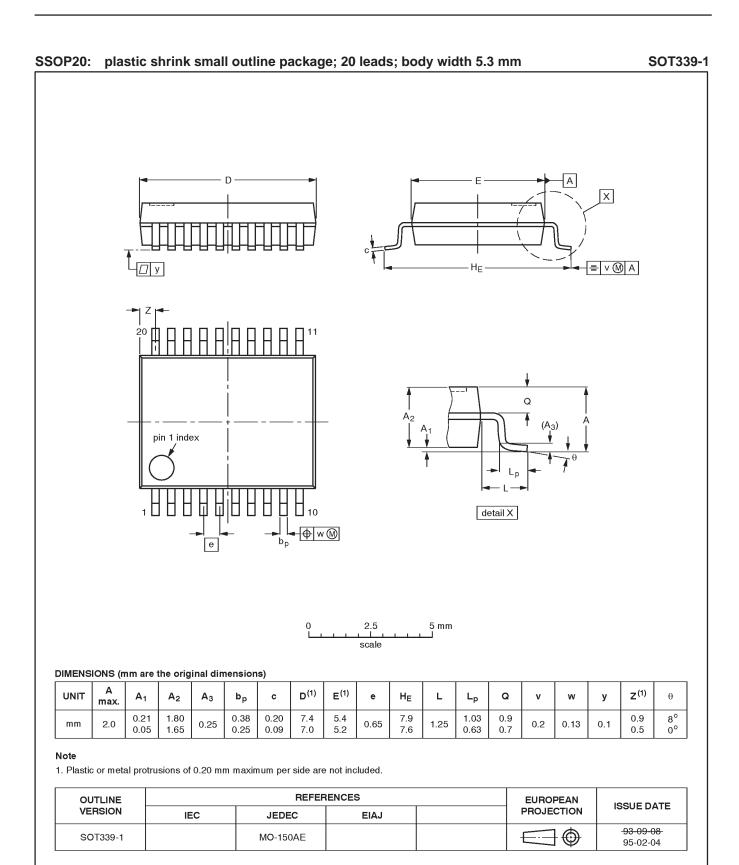
- 1. All input pulses are supplied by generators having the following characteristics: PRR \leq 10MHz, Z₀ = 50 Ω , t_r \leq 2.5 ns, t_f \leq 2.5 ns.
- 2. The outputs are measured one at a time with one transition per measurement.

TEST CIRCUIT AND WAVEFORMS

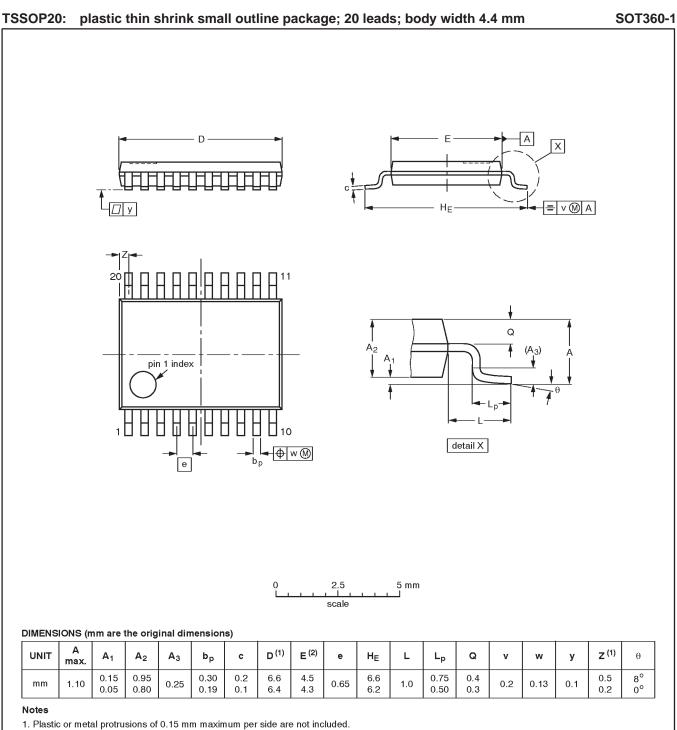
CBT3244



CBT3244



CBT3244



Plastic of metal profusions of 0.15 mm maximum per side are not included.
 Plastic interlead protrusions of 0.25 mm maximum per side are not included.

 OUTLINE VERSION
 REFERENCES
 EUROPEAN PROJECTION
 ISSUE DATE

 SOT360-1
 MO-153AC
 EIAJ
 95-02-04

Preliminary specification

CBT3244

Octal bus switch with Quad Output Enables

NOTES

CBT3244

Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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